

CMOS Digital Integrated Circuits Silicon Monolithic

# TC7USB42MU

#### 1. Functional Description

· Dual SPDT USB Switch

#### 2. General

The TC7USB42MU is high-speed CMOS dual 1-2 multiplexer/demultiplexer. The low ON-resistance and the low capacitance of the switch allow connections to USB2.0 (480Mbps) application.

This device consists of dual individual two-inputs multiplexer/demultiplexer with common select input (S) and output enable  $(\overline{OE})$ . The D+/D- inputs is connected to the 1D+/1D- or 2D+/2D- outputs determined by the combination both the select input (S) and output enable  $(\overline{OE})$ . When the output enable  $(\overline{OE})$  input is held high level, the switches are open with regardless the state of select inputs and a high-impedance state exists between the switches.

All inputs are equipped with protection circuits against static discharge.

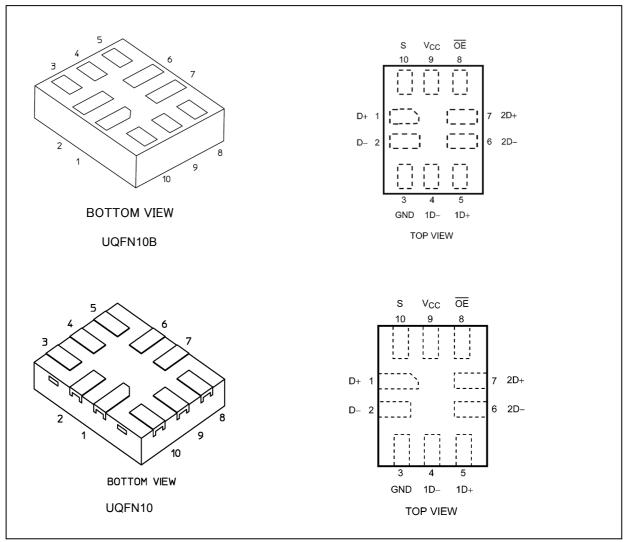
#### 3. Features

- (1) Supply voltage:  $V_{CC} = 2.3 \text{ to } 4.3 \text{ V}$
- (2) Switch terminal ON-capacitance:  $C_{I/O} = 5$  pF Switch ON (typ.) @ $V_{CC} = 3.3$  V
- (3) ON-resistance:  $R_{ON} = 4.5 \Omega$  (typ.) @ $V_{CC} = 3 V$ ,  $V_{IS} = 0 V$
- (4)  $R_{ON}$  flatness:  $R_{ON(flat)} = 1.3 \Omega$  (typ.)@ $V_{CC} = 3 V$
- (5) Difference of ON-resistance between switches:  $\Delta R_{ON} = 0.35 \Omega$  (typ.)@ $V_{CC} = 3 V$
- (6) Power-down protection provided on all inputs and outputs.
- (7) Ultra-small Package: UQFN10B, UQFN10

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## 4. Packaging and Pin Assignment (Note)



Note: The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

## 5. Marking

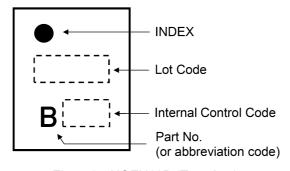


Fig. 5.1 UQFN10B (Top view)

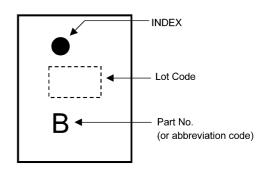


Fig. 5.2 UQFN10 (Top view)



## 6. Block Diagram

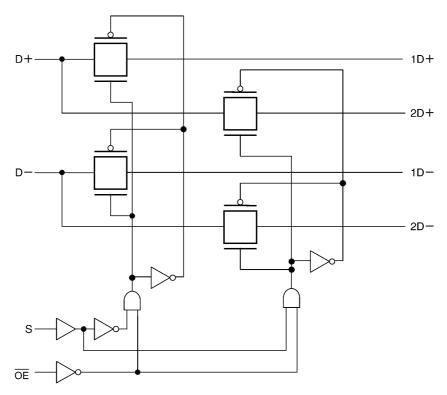


Fig. 6.1 Block Diagram

## 7. Principle of Operation

## 7.1. Truth Table

Input OE	Input S	Function
L	L	D+ port = 1D+ port, D- Port = 1D- Port
L	Н	D+ port = 2D+ port, D- Port = 2D- Port
Н	Х	Disconnect

X: Don't care



## 8. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		_	-0.5 to 4.6	V
Input voltage (OE, S)	V <sub>IN</sub>			-0.5 to 4.6	
Switch I/O voltage	Vs		V <sub>CC</sub> = 0 V or Switch OFF	-0.5 to 4.6	
			Switch ON	-0.5 to V <sub>CC</sub> +0.5	
Clamp diode current	I <sub>IK</sub>		Control input	-50	mA
			Switch	±50	
Switch I/O current	I <sub>S</sub>		_	50	
Power dissipation	P <sub>D</sub>			200	mW
V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>			±100	mA
Storage temperature	T <sub>stg</sub>			-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 9. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		_	2.3 to 4.3	V
Input voltage (OE, S)	V <sub>IN</sub>			0 to 4.3	
Switch I/O voltage	Vs		V <sub>CC</sub> = 0 V or Switch OFF	0 to 4.3	
			Switch ON	0 to V <sub>CC</sub>	
Operating temperature	T <sub>opr</sub>		_	-40 to 85	°C
Input rise time	dt/dv			0 to 10	ns/V
Input fall time				0 to 10	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either  $V_{\text{CC}}$  or GND.



#### 10. Electrical Characteristics

## 10.1. DC Characteristics (Note) (Unless otherwise specified, Ta = -40 to 85°C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage (OE, S)	V <sub>IH</sub>			2.3 to 3.0	0.50 × V <sub>CC</sub>		_	V
				3.0 to 4.3	0.46 × V <sub>CC</sub>	l		
Low-level input voltage (OE, S)	V <sub>IL</sub>		_	2.3 to 4.3	1	ı	0.25 × V <sub>CC</sub>	
Input leakage current (OE, S)	I <sub>IN</sub>		V <sub>IN</sub> = 0 to 4.3 V	2.3 to 4.3			±1	μА
Power-OFF leakage current	I <sub>OFF</sub>		V <sub>IN</sub> = V <sub>IS</sub> = 0 to 4.3 V, See Fig. 11.10	0			±2	
Switch OFF-state leakage current	I <sub>SZ</sub>		$V_{IS}$ = 0 to 3.6 V, $\overline{OE}$ = $V_{CC}$ , See Fig. 11.11	2.3 to 4.3		_	±2	
ON-resistance	R <sub>ON</sub>	(Note 1)	$V_{IS} = 0 \text{ V}, I_{IS} = 30 \text{ mA},$ See Fig. 11.9	3.0	_	4.5	6	Ω
			$V_{IS}$ = 0.4 V, $I_{IS}$ = 30 mA, See Fig. 11.9	3.0	_	4.8	6.7	
			$V_{IS}$ = 3.0 V, $I_{IS}$ = 30 mA, See Fig. 11.9	3.0	_	10	14	
Difference of ON-resistance between switches	ΔR <sub>ON</sub>	(Note 1)	V <sub>IS</sub> = 0.4 V, 1.0 V, I <sub>IS</sub> = 30 mA	3.0		0.35		
ON-resistance flatness	R <sub>ON(flat)</sub>	(Note 1)	V <sub>IS</sub> = 0 V to 1.0 V, I <sub>IS</sub> = 30 mA	3.0	_	1.3	_	
Quiescent supply current	Icc		$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$ A	4.3	_		1	μА
	Δl <sub>CC</sub>		V <sub>IN</sub> = 2.6 V (one input)	4.3	_	_	40	

Note: All typical values are at  $T_a = 25$ °C.

Note 1: Measured by the voltage drop between D+/D- and 1D+/1D-,2D+/2D- pins at the indicated current through the switch. On-resistance is determined by the lower of the voltages on the two pins.

## 10.2. AC Characteristics (Note) (Unless otherwise specified, T<sub>a</sub> = -40 to 85°C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Propagation delay time	t <sub>PLH</sub> /	(Note 1)	C <sub>L</sub> = 5 pF, See Fig. 11.1	3.3 ± 0.3	_	0.25	_	ns
Turn-ON time (S, OE to output)	t <sub>on</sub>		$R_L = 50 \Omega, C_L = 5 pF,$ See Fig. 11.2		_	10	20	
Turn-OFF time (S, OE to output)	t <sub>off</sub>				_	14	24	
Break before make	TBBM		$R_L = 50 \Omega, C_L = 5 pF,$ See Fig. 11.3		2	_	7	
Skew of opposite transitions of the same output (t <sub>PHL</sub> - t <sub>PLH</sub> )	t <sub>SK(P)</sub>	(Note 1)	C <sub>L</sub> = 5 pF, See Fig. 11.4		ı	0.1	ı	
Output skew (center port to any other port)	t <sub>SK(O)</sub>	(Note 1)	C <sub>L</sub> = 5 pF, See Fig. 11.5		_	0.1	_	

Note: All typical values are at  $T_a = 25^{\circ}$ C. Note 1: Parameter guaranteed by design.



## 10.3. Analog Switch (Note) (Unless otherwise specified, $T_a = -40$ to 85°C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
OFF isolation (non-adjacent)	OIRR		$R_T$ = 50 $\Omega$ , f = 240 MHz, See Fig. 11.6	$3.3\pm0.3$	_	-24		dB
Crosstalk (non-adjacent)	Xtalk		$R_T$ = 50 $\Omega$ , f = 240 MHz, See Fig. 11.7		_	-30	-	
-3dB Bandwidth	BW		$R_T = 50 \Omega$ , $C_L = 0 pF$ , See Fig. 11.8		_	1500		MHz

Note: All typical values are at  $T_a = 25$ °C. Parameter guaranteed by design.

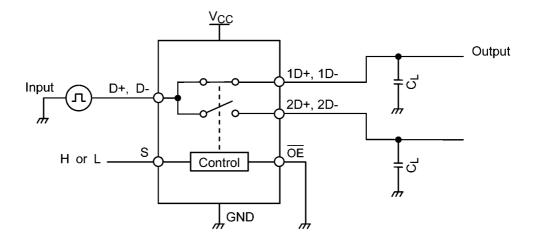
## 10.4. Capacitive Characteristics (Note) (Unless otherwise specified, T<sub>a</sub> = 25°C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance (OE, S)	C <sub>IN</sub>		V <sub>IN</sub> = 0 V	3.3	3	pF
Switch terminal OFF-capacitance (D+, D-)	C <sub>I/O</sub>		$\overline{OE} = V_{CC}, V_{IS} = 0 V$		3	
Switch terminal OFF-capacitance (1D+, 1D-, 2D+, 2D-)					2	
Switch terminal ON-capacitance			OE = GND, V <sub>IS</sub> = 0 V		5	

Note: Parameter guaranteed by design.



## 11. AC Test Circuits and Waveforms



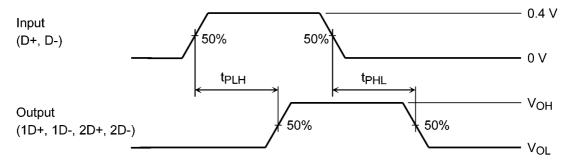
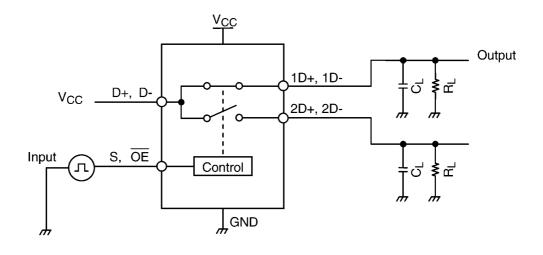


Fig. 11.1 Propagation Delay Time (t<sub>PLH</sub>, t<sub>PHL</sub>)

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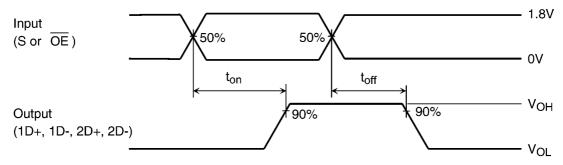


Fig. 11.2 Turn-ON and Turn-OFF Times (ton, toff)

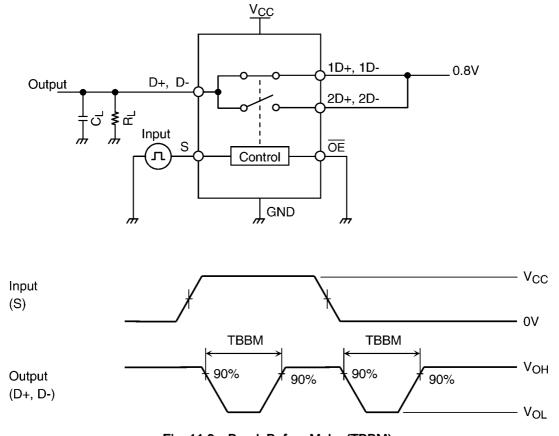
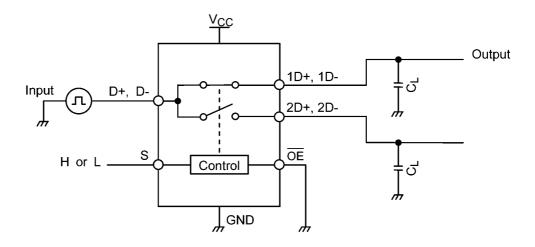


Fig. 11.3 Break Before Make (TBBM)

Rev.4.0





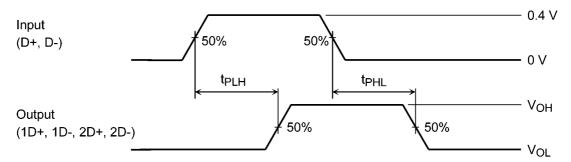


Fig. 11.4 Skew of opposite transitions of the same output  $(t_{SK(P)} = |t_{PHL} - t_{PLH}|)$ 

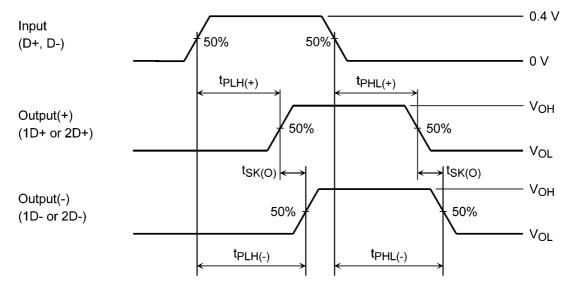


Fig. 11.5 Output Skew (center port to any other port)

Rev.4.0



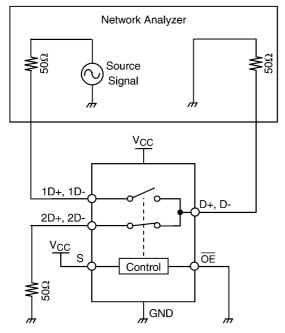


Fig. 11.6 OFF Isolation

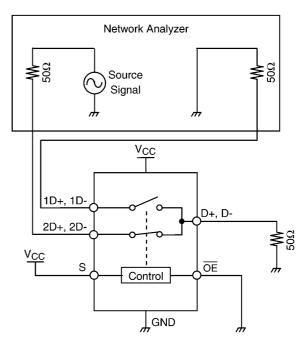


Fig. 11.7 Crosstalk

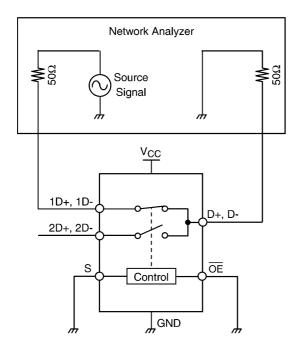


Fig. 11.8 -3dB Bandwidth



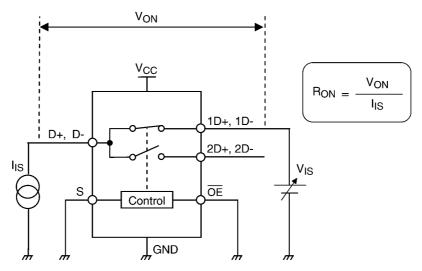


Fig. 11.9 ON-Resistance

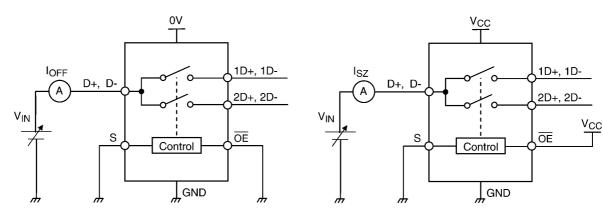


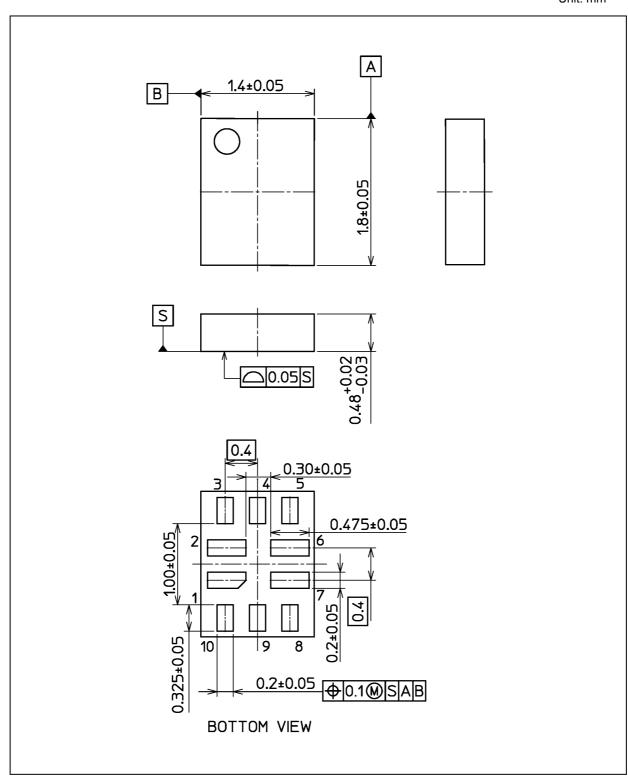
Fig. 11.10 Power-OFF Leakage Current

Fig. 11.11 Switch OFF-state leakage current



## **Package Dimensions**

Unit: mm



This resins used in this product include no flame retardants.

The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

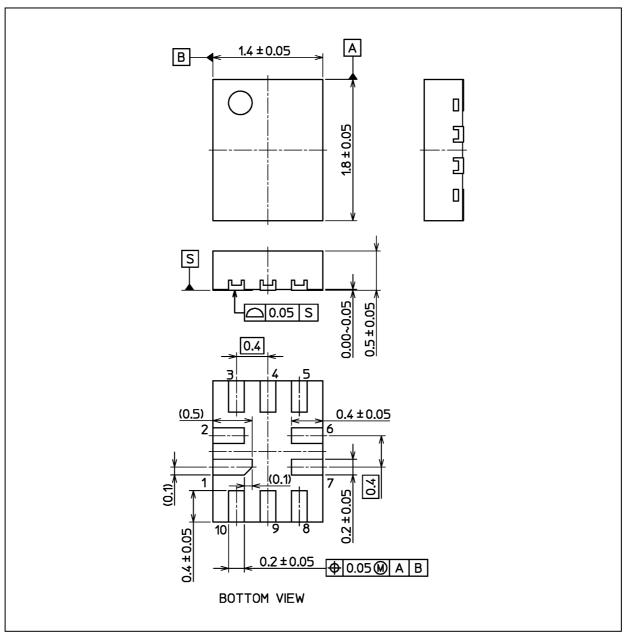
Weight: 4.0 mg (typ.)

	Package Name(s)
Nickname: UQFN10B	



## **Package Dimensions**

Unit: mm



This resins used in this product include no flame retardants.

The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

Weight: 3.5 mg (typ.)

	Package Name(s)
Nickname: UQFN10	



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